

## N-Channel Enhancement Mode Power MOSFET

### Description

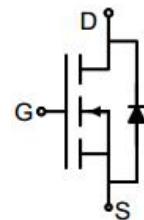
The G080N10M uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

### General Features

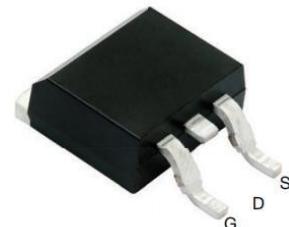
- $V_{DS}$  100V
- $I_D$  (at  $V_{GS} = 10V$ ) 140A
- $R_{DS(ON)}$  (at  $V_{GS} = 10V$ ) < 7.5mΩ
- $R_{DS(ON)}$  (at  $V_{GS} = 4.5V$ ) < 8mΩ
- 100% Avalanche Tested
- RoHS Compliant

### Application

- Power switch
- DC/DC converters



Schematic diagram



TO-263

### Ordering Information

Device	Package	Marking	Packaging
G080N10M	TO-263	G080N10	800pcs/Reel

### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Continuous Drain Current	$I_D$	140	A
Pulsed Drain Current (note1)	$I_{DM}$	560	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Power Dissipation	$P_D$	236	W
Single pulse avalanche energy (note2)	$E_{AS}$	361	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	°C

### Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62	°C/W
Maximum Junction-to-Case	$R_{thJC}$	0.53	°C/W

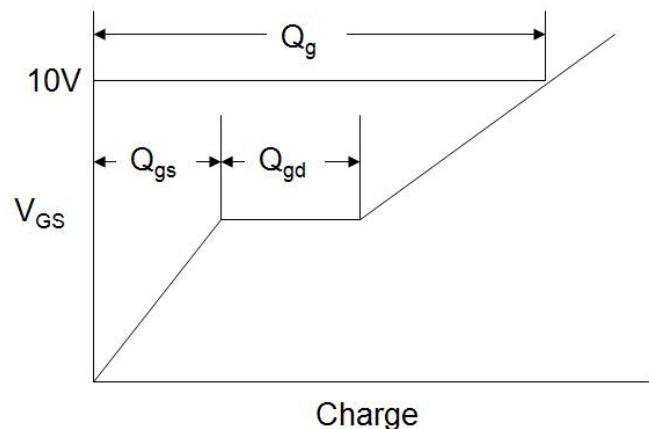
**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.0	1.7	2.5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 30\text{A}$	--	5.6	7.5	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 30\text{A}$	--	6.2	8.0	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{GS}} = 5\text{V}, I_D = 30\text{A}$	--	59	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 1.0\text{MHz}$	--	13950	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	432	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	362	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 50\text{V}, I_D = 30\text{A}, V_{\text{GS}} = 10\text{V}$	--	192	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	49	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	23	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 50\text{V}, I_D = 30\text{A}, R_G = 4.7\Omega$	--	32	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	118	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	80	--	
Turn-off Fall Time	$t_f$		--	27	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	140	A
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 30\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_F = 30\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$	--	212	--	$\text{nC}$
Reverse Recovery Time	$T_{\text{rr}}$		--	96	--	ns

**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_G=25\Omega$
3. Identical low side and high side switch with identical  $R_G$

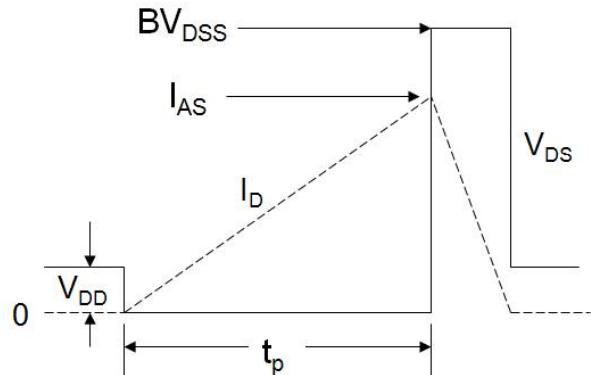
### Gate Charge Test Circuit



### Switch Time Test Circuit

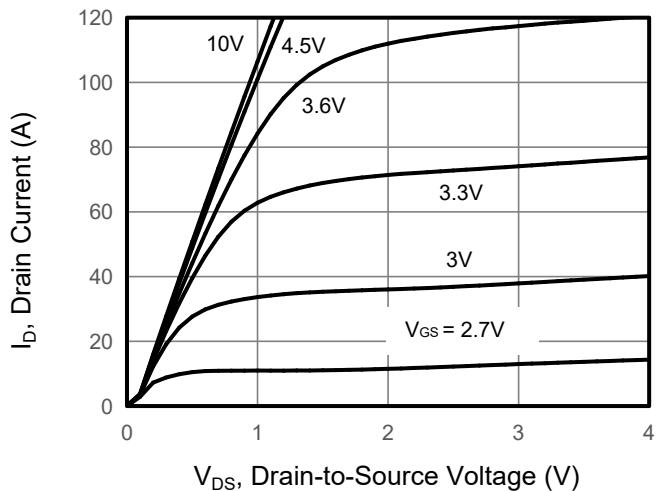


### EAS Test Circuit

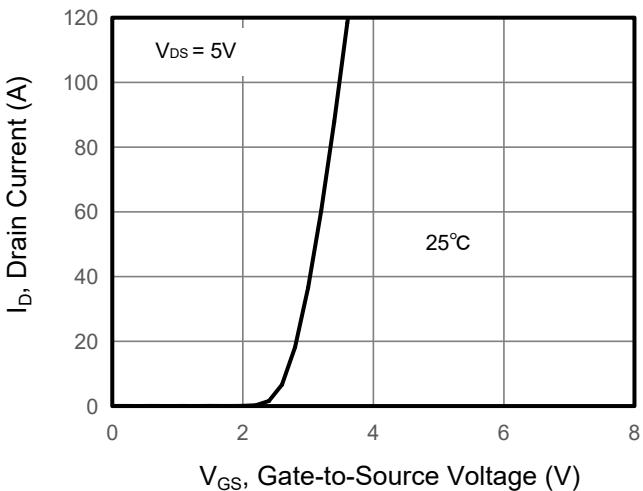


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

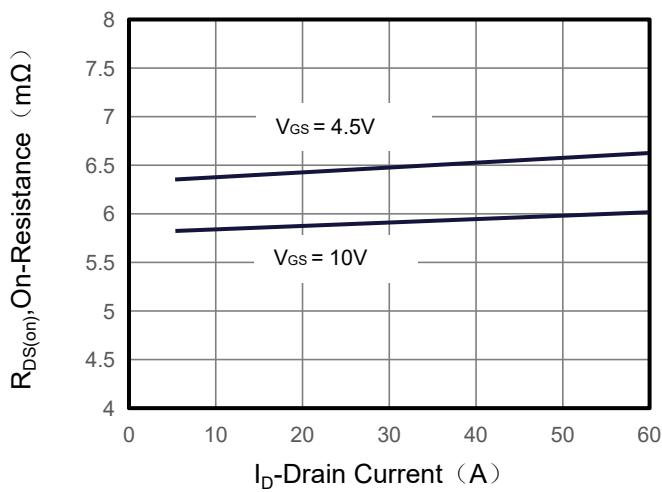
**Figure 1. Output Characteristics**



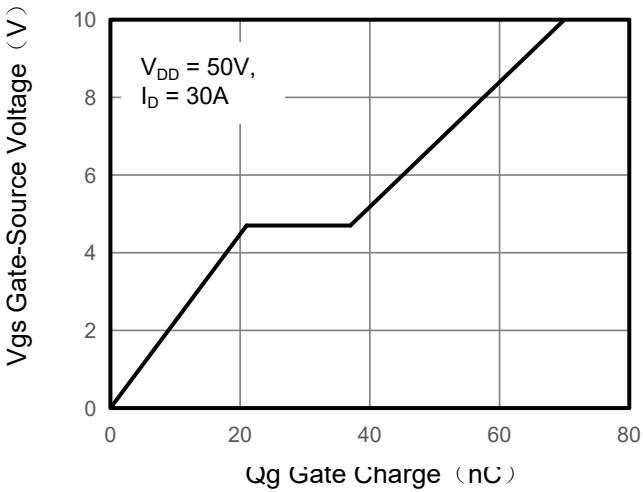
**Figure 2. Transfer Characteristics**



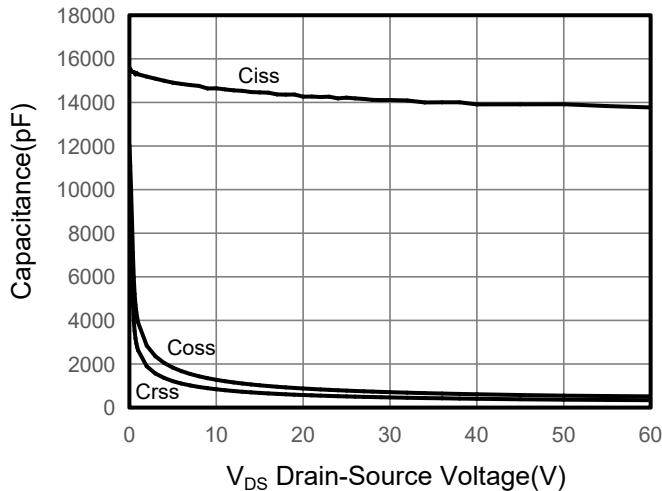
**Figure 3. Drain Source On Resistance**



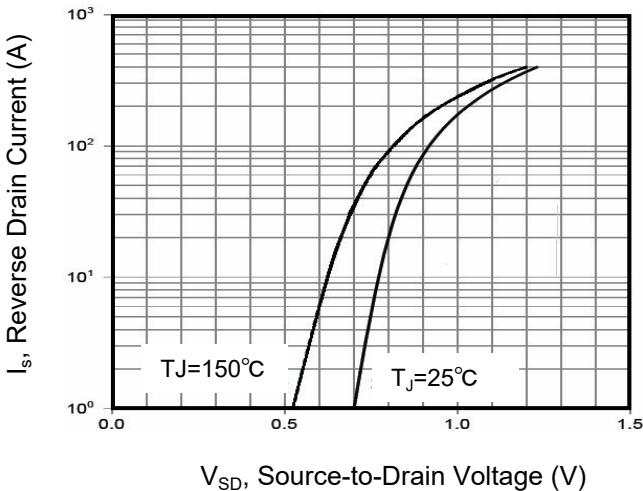
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

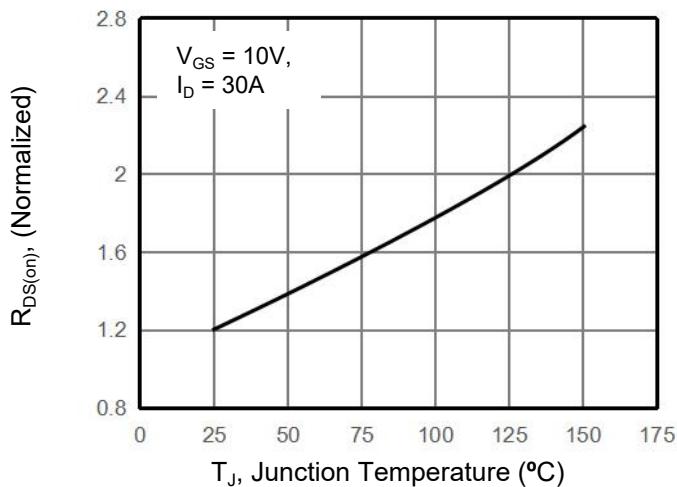


**Figure 6. Source-Drain Diode Forward**

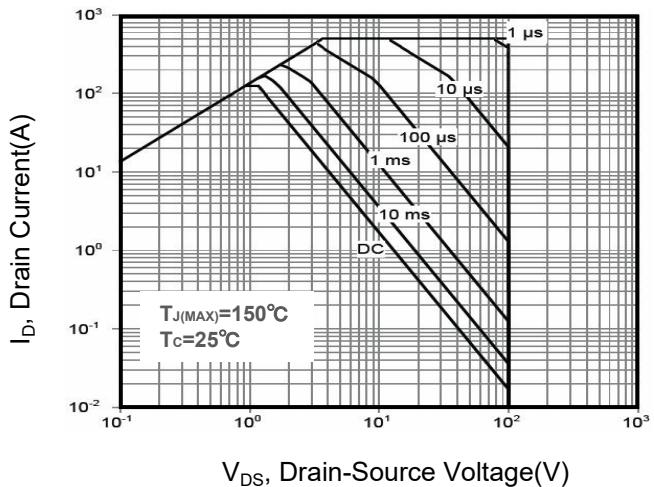


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

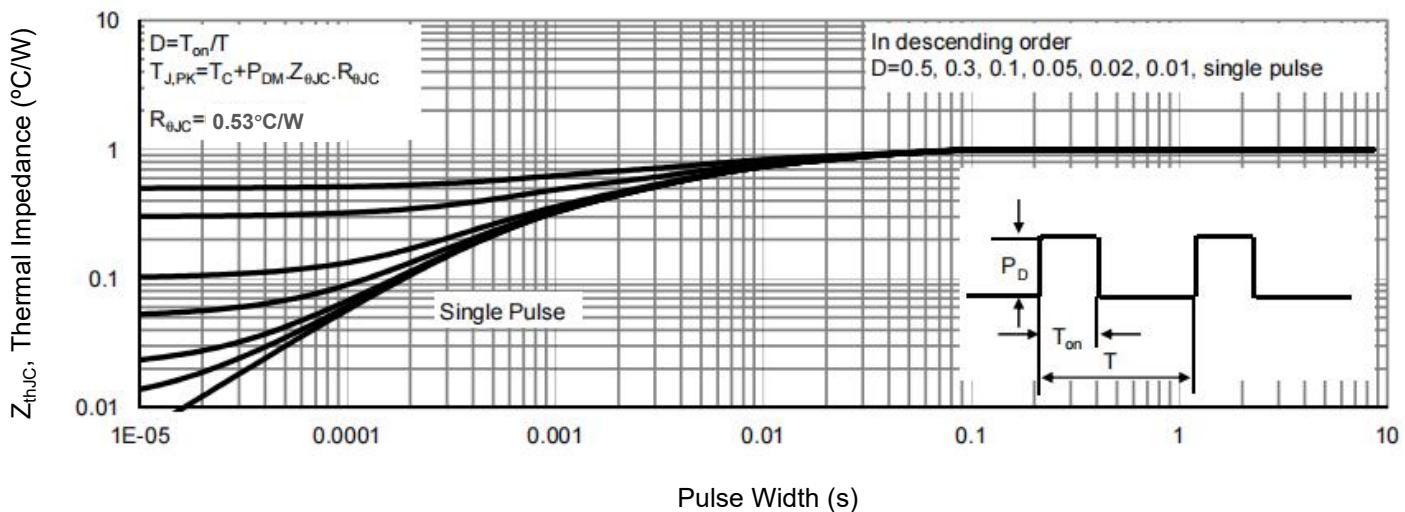
**Figure 7. Drain-Source On-Resistance**



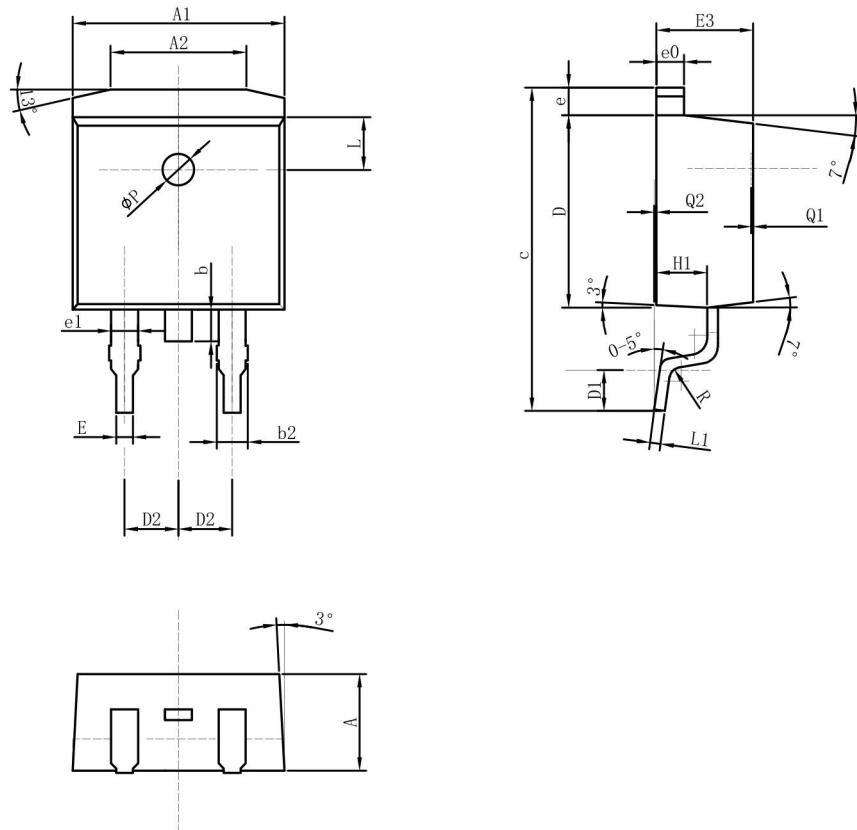
**Figure 8. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



## TO-263 Package Information



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.52	4.57	4.62
A1	9.95	10.00	10.05
A2	6.30	6.40	6.50
b	1.30	1.50	1.70
b2	1.17	1.27	1.37
c	14.80	15.00	15.20
D	9.05	9.10	9.15
D1	1.90	2.10	2.30
D2	—	2.54	—
E	—	0.80	—
E3	—	4.57	—
e	—	1.30	—
e0	—	1.30	—
e1	1.73	3	—
H1	—	2.40	—
L	—	2.50	—
L1	—	0.50	—
φP	—	1.50	—
R	—	0.50	—
Q1	0.10	—	0.15
Q2	0	—	0.02